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PCA9538

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PCA9538 Remote 8-Bit I²C AND SMBus Low-power I/O Expander With Interrupt Output, Reset, and Configuration Registers

1 Features

- Low Standby Current Consumption of 1 μA Max
- I²C to Parallel Port Expander
- · Open-Drain Active-Low Interrupt Output
- Active-Low Reset Input
- Operating Power-Supply Voltage Range of 2.3 V to 5.5 V
- 5-V Tolerant I/O Ports
- 400-kHz Fast I²C Bus
- Two Hardware Address Pins Allow up to Four Devices on the I²C/SMBus
- Input/Output Configuration Register
- · Polarity Inversion Register
- Power-Up With All Channels Configured as Inputs
- No Glitch on Power Up
- Noise Filter on SCL/SDA Inputs
- Latched Outputs With High-Current Drive Maximum Capability for Directly Driving LEDs
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

2 Description

This 8-bit I/O expander for the two-line bidirectional bus (I^2C) is designed for 2.3-V to 5.5-V V_{CC} operation. It provides general-purpose remote I/O expansion for most microcontroller families via the I^2C interface [serial clock (SCL), serial data (SDA)].

The PCA9538 consists of one 8-bit Configuration (input or output selection), Input Port, Output Port, and Polarity Inversion (active high or active low) registers. At power on, the I/Os are configured as inputs. However, the system master can enable the I/Os as either inputs or outputs by writing to the I/O configuration bits. The data for each input or output is kept in the corresponding Input Port or Output Port register. The polarity of the Input Port register can be inverted with the Polarity Inversion register. All registers can be read by the system master.

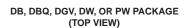
The system master can reset the PCA9538 in the event of a timeout or other improper operation by asserting a low in the RESET input. The power-on reset puts the registers in their default state and initializes the I²C/SMBus state machine. The RESET pin causes the same reset/initialization to occur without powering down the part.

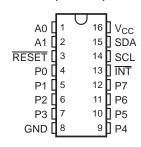
The PCA9538 open-drain interrupt ($\overline{\text{INT}}$) output is activated when any input state differs from its corresponding Input Port register state and is used to indicate to the system master that an input state has changed.

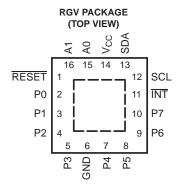
Device Information⁽¹⁾

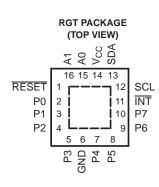
PART NUMBER	PACKAGE	BODY SIZE (NOM)	
TCA6424	SSOP (16)	6.20 mm × 5.30 mm	
	TVSOP (16)	3.60 mm × 4.40 mm	
	SOIC (16)	10.30 mm 7.50 mm	
	TSSOP (16)	5.00 mm × 4.40 mm	

(1) For all available packages, see the orderable addendum at the end of the datasheet.









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SCPS126F - SEPTEMBER 2006 - REVISED JUNE 2014

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Table of Contents

1	Features 1	7 Parameter Measurement Information	10
2	Description 1	8 Detailed Description	14
3	Revision History2	8.1 Functional Block Diagram	14
4	Description (Continued)3	8.2 Device Functional Modes	16
5	Pin Configuration and Functions3	8.3 Programming	17
6	Specifications4	9 Application And Implementation	24
•	6.1 Absolute Maximum Ratings	9.1 Typical Application	24
	6.2 Handling Ratings	10 Power Supply Recommendations	26
	6.3 Recommended Operating Conditions 4	10.1 Power-On Reset Errata	26
	6.4 Electrical Characteristics5	11 Device and Documentation Support	27
	6.5 I ² C Interface Timing Requirements	11.1 Trademarks	27
	6.6 RESET Timing Requirements	11.2 Electrostatic Discharge Caution	27
	6.7 Switching Characteristics 6	11.3 Glossary	27
	6.8 Typical Characteristics	12 Mechanical, Packaging, and Orderable Information	27

3 Revision History

CI	anges from Revision E (September 2008) to Revision F					
•	Added RESET Errata section.	16				
•	Added Interrupt Errata section	17				
•	Power-On Reset Errata section.	26				

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4 Description (Continued)

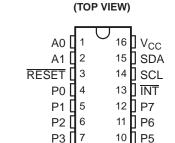
INT can be connected to the interrupt input of a microcontroller. By sending an interrupt signal on this line, the remote I/O can inform the microcontroller if there is incoming data on its ports without having to communicate via the I²C bus. Thus, the PCA9538 can remain a simple slave device.

The device outputs (latched) have high-current drive capability for directly driving LEDs. It has low current consumption.

Two hardware pins (A0 and A1) are used to program and vary the fixed I^2C address and allow up to four devices to share the same I^2C bus or SMBus.

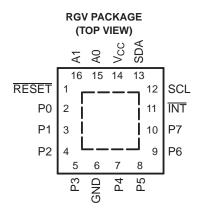
5 Pin Configuration and Functions

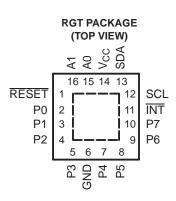
DB, DBQ, DGV, DW, OR PW PACKAGE



GND [

9 N P4





Pin Functions

F	PIN				
	N	0.			
NAME	QSOP (DBQ), SSOP (DB), TSSOP (PW), OR TVSOP (DGV)	QFN (RGT) OR QFN (RGV)	DESCRIPTION		
A0	1	15	Address input. Connect directly to V _{CC} or ground.		
A1	2	16	Address input. Connect directly to V _{CC} or ground.		
RESET	3	1	Active-low reset input. Connect to V_{CC} through a pullup resistor if no active connection is used.		
P0	4	2	P-port input/output. Push-pull design structure.		
P1	5	3	P-port input/output. Push-pull design structure.		
P2	6	4	P-port input/output. Push-pull design structure.		
P3	7	5	P-port input/output. Push-pull design structure.		
GND	8	6	Ground		
P4	9	7	P-port input/output. Push-pull design structure.		
P5	10	8	P-port input/output. Push-pull design structure.		
P6	11	9	P-port input/output. Push-pull design structure.		
P7	12	10	P-port input/output. Push-pull design structure.		
ĪNT	13	11	Interrupt output. Connect to V _{CC} through a pullup resistor.		
SCL	14	12	Serial clock bus. Connect to V _{CC} through a pullup resistor.		
SDA	15	13	Serial data bus. Connect to V _{CC} through a pullup resistor.		
V _{CC}	16	14	Supply voltage		



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6 Specifications

6.1 Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V _{CC}	Supply voltage range		-0.5	6	V
VI	Input voltage range (2)		-0.5	6	V
Vo	Output voltage range ⁽²⁾		-0.5	6	V
I _{IK}	Input clamp current	V _I < 0		-20	mA
I _{OK}	Output clamp current	V _O < 0		-20	mA
I _{IOK}	Input/output clamp current	$V_O < 0$ or $V_O > V_{CC}$		±20	mA
I _{OL}	Continuous output low current	$V_O = 0$ to V_{CC}		50	mA
I _{OH}	Continuous output high current	$V_O = 0$ to V_{CC}		-50	mA
	Continuous current through GND			-250	A
I _{CC}	Continuous current through V _{CC}			160	mA
		DB package		82	
		DBQ package		90	
		DGV package		86	°C/W
θ_{JA}	Package thermal impedance (3)	DW package		46	
		PW package		88	
		RGT package		TBD	
		RGV package		TBD	

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

6.2 Handling Ratings

			MIN	MAX	UNIT
T _{stg}	Storage temperature rang	ge	-65	150	°C
V _(ESD)	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins (1)	0	2000	V
		Charged device model (CDM), per JEDEC specification JESD22-C101, all pins (2)	0	1000	

⁽¹⁾ JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT	
V_{CC}	Supply voltage		2.3	5.5	V	
.,	I Bala Tarrat Samurk redka ara	SCL, SDA	0.7 × V _{CC}	5.5	1/	
V _{IH}	High-level input voltage	A0, A1, RESET, P7-P0	2	5.5	V	
\/	Low-level input voltage	SCL, SDA	-0.5	$0.3 \times V_{CC}$	V	
V _{IL}		A0, A1, RESET, P7-P0	-0.5	0.8	V	
I _{OH}	High-level output current	P7–P0		-10	mA	
I _{OL}	Low-level output current	P7–P0		25	mA	
T _A	Operating free-air temperature		-40	85	°C	

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⁽³⁾ The package thermal impedance is calculated in accordance with JESD 51-7.

⁽²⁾ JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



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6.4 Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	V _{CC}	MIN	TYP ⁽¹⁾	MAX	UNIT
V _{IK}	Input diode clamp voltage	I _I = -18 mA	2.3 V to 5.5 V	-1.2			V
V _{POR}	Power-on reset voltage	$V_I = V_{CC}$ or GND, $I_O = 0$	V _{POR}		1.5	1.65	V
			2.3 V	1.8			
			3 V	2.6			
		$I_{OH} = -8 \text{ mA}$	4.5 V	4.1			
			4.75 V	4.1			
V_{OH}	P-port high-level output voltage ⁽²⁾		2.3 V	1.7			V
			3 V	2.5			
		$I_{OH} = -10 \text{ mA}$	4.5 V	4			
			4.75 V	4			
	SDA	V _{OL} = 0.4 V	2.3 V to 5.5 V	3	8		
			2.3 V	8	10		
			3 V	8	14		
		V _{OL} = 0.5 V	4.5 V	8	17		
	(2)		4.75 V	8	35		
I_{OL}	P port ⁽³⁾		2.3 V	10	13		mA
			3 V	10	19		
		V _{OL} = 0.7 V	4.5 V	10	24		
			4.75 V	10	45		
	ĪNT	V _{OL} = 0.4 V	2.3 V to 5.5 V	3	10		
	SCL, SDA					±1	μА
l _l	A0, A1, RESET	$V_I = V_{CC}$ or GND	2.3 V to 5.5 V			±1	
I _{IH}	P port	$V_{I} = V_{CC}$	2.3 V to 5.5 V			1	μA
I _{IL}	P port	$V_1 = GND$	2.3 V to 5.5 V			-1	μA
- IL			5.5 V		104	175	
		$V_I = V_{CC}$ or GND, $I_O = 0$,	3.6 V		50	90	
		$I/O = inputs, f_{scl} = 400 \text{ kHz}, No load$	2.7 V		20	65	
	Operating mode		5.5 V		60	150	
I _{CC}		$V_I = V_{CC}$ or GND, $I_O = 0$,	3.6 V		15	40	μA
00		$I/O = inputs, f_{scl} = 100 \text{ kHz}, No load$	2.7 V		8	20	
			5.5 V		0.25	1	
	Standby mode	$V_I = V_{CC}$ or GND, $I_O = 0$,	3.6 V		0.2	0.9	
	Clairaby inicac	$I/O = inputs, f_{scl} = 0 \text{ kHz}, No load}$	2.7 V		0.1	0.8	
ΔI _{CC}	Additional current in standby	One input at V _{CC} = 0.6 V, Other inputs at V _{CC} or GND	2.3 V to 5.5 V			1.5	
	mode	All LED I/Os at $V_I = 4.3 \text{ V}$, $f_{scl} = 0 \text{ kHz}$	5.5 V			1	mA
C _i	SCL	$V_I = V_{CC}$ or GND	2.3 V to 5.5 V		4	5	pF
	SDA				5.5	6.5	
C_{io}	P port	$V_{IO} = V_{CC}$ or GND	2.3 V to 5.5 V		8	9.5	pF

All typical values are at nominal supply voltage (2.5-V, 3.3-V, or 5-V V_{CC}) and T_A = 25°C. The total current sourced by all I/Os must be limited to 85 mA.

Each I/O must be externally limited to a maximum of 25 mA, and the P port (P7-P0) must be limited to a maximum current of 200 mA.



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6.5 I²C Interface Timing Requirements

over operating free-air temperature range (unless otherwise noted) (see Figure 14)

			STANDARD I ² C BU		FAST MOD I ² C BUS		UNIT
			MIN	MAX	MIN	MAX	
f _{scl}	I ² C clock frequency		0	100	0	400	kHz
t _{sch}	I ² C clock high time		4		0.6		μs
t _{scl}	I ² C clock low time		4.7		1.3		μs
t _{sp}	I ² C spike time			50		50	ns
t _{sds}	I ² C serial-data setup time		250		100		ns
t _{sdh}	I ² C serial-data hold time		0		0		ns
t _{icr}	I ² C input rise time			1000	20 + 0.1C _b ⁽¹⁾	300	ns
t _{icf}	I ² C input fall time			300	20 + 0.1C _b ⁽¹⁾	300	ns
t _{ocf}	I ² C output fall time	10-pF to 400-pF bus		300	20 + 0.1C _b ⁽¹⁾	300	ns
t _{buf}	I ² C bus free time between Stop and	d Start	4.7		1.3		μs
t _{sts}	I ² C Start or repeated Start condition	n setup	4.7		0.6		μs
t _{sth}	I ² C Start or repeated Start condition	n hold	4		0.6		μs
t _{sps}	I ² C Stop condition setup		4		0.6		μs
t _{vd(data)}	Valid data time	SCL low to SDA output valid	300		50		ns
t _{vd(ack)}	Valid data time of ACK condition	ACK signal from SCL low to SDA (out) low	0.3	3.45	0.1	0.9	μs
C _b	I ² C bus capacitive load			400		400	ns

⁽¹⁾ C_b = Total capacitance of one bus in pF

6.6 RESET Timing Requirements

over operating free-air temperature range (unless otherwise noted)

PARAMETER		STANDARD MODE I ² C BUS		FAST MODE I ² C BUS		UNIT	
		MIN	MAX	MIN	MAX		
t_W	Reset pulse duration	4		4		ns	
t _{REC}	Reset recovery time	0		0		ns	
t _{RESET}	Time to reset	400		400		ns	

6.7 Switching Characteristics

over operating free-air temperature range (unless otherwise noted) (see Figure 15 and Figure 16)

	PARAMETER	FROM (INPUT)	TO (OUTPUT)	STANDARD MODE I ² C BUS	FAST MODE I ² C BUS	UNIT
(INPO1)	(INFOT)	(001701)	MIN MAX	MIN MAX		
t _{iv}	Interrupt valid time	P port	ĪNT	4	4	μs
t _{ir}	Interrupt reset delay time	SCL	ĪNT	4	4	μs
t _{pv}	Output data valid	SCL	P7-P0	200	200	ns
t _{ps}	Input data setup time	P port	SCL	100	100	ns
t _{ph}	Input data hold time	P port	SCL	1	1	μs

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6.8 Typical Characteristics

 $T_A = 25$ °C (unless otherwise noted)

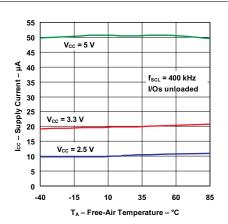


Figure 1. Supply Current vs Temperature

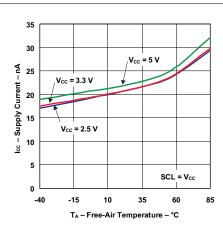


Figure 2. Quiescent Supply Current vs Temperature

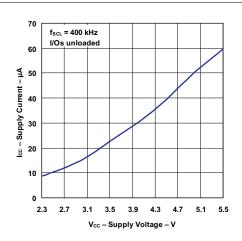


Figure 3. Supply Current vs Supply Voltage

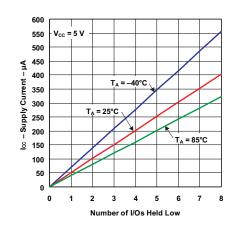


Figure 4. Supply Current vs Number Of I/Os Held Low

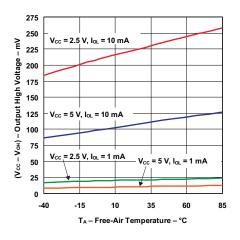


Figure 5. I/O Output Low Voltage vs Temperature

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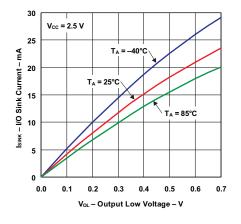


Figure 6. I/O Sink Current vs Output Low Voltage

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Typical Characteristics (continued)

 $T_A = 25$ °C (unless otherwise noted)

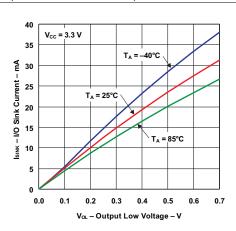


Figure 7. I/O Sink Current vs Output Low Voltage

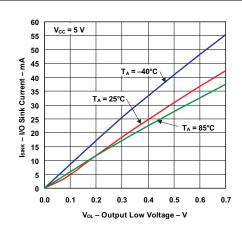


Figure 8. I/O Sink Current vs Output Low Voltage

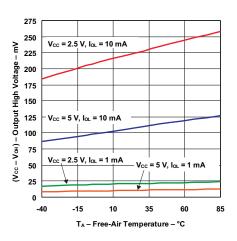


Figure 9. I/O Output High Voltage vs Temperature

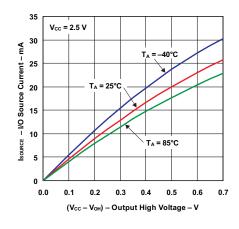


Figure 10. I/O Source Current vs Output High Voltage

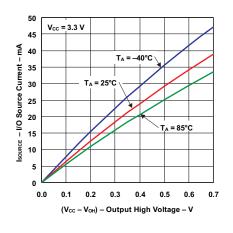


Figure 11. I/O Source Current vs Output High Voltage

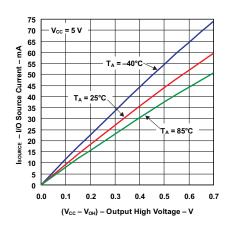


Figure 12. I/O Source Current vs Output High Voltage

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Typical Characteristics (continued)

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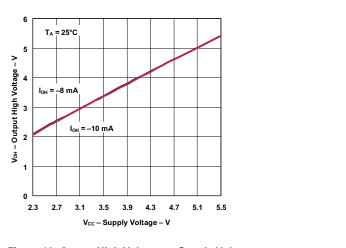


Figure 13. Output High Voltage vs Supply Voltage

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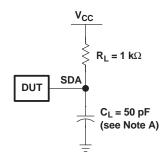


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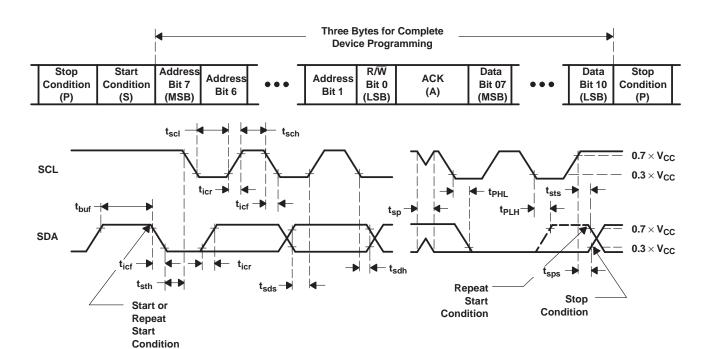
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7 Parameter Measurement Information



SDA LOAD CONFIGURATION



VOLTAGE WAVEFORMS

BYTE DESCRIPTION			
1	I ² C address		
2, 3	P-port data		

- A. C_L includes probe and jig capacitance.
- B. All inputs are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_0 = 50~\Omega$, $t_r/t_f \leq$ 30 ns.
- C. All parameters and waveforms are not applicable to all devices.

Figure 14. I²C Interface Load Circuit And Voltage Waveforms

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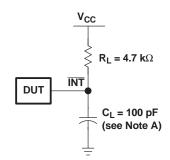


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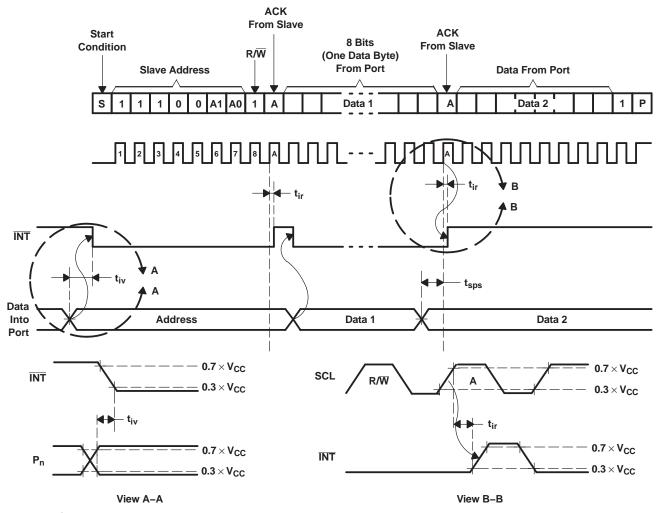
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Parameter Measurement Information (continued)



INTERRUPT LOAD CONFIGURATION



- A. C_L includes probe and jig capacitance.
- B. All inputs are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_0 = 50 \ \Omega$, $t_r/t_f \leq$ 30 ns.
- C. All parameters and waveforms are not applicable to all devices.

Figure 15. Interrupt Load Circuit And Voltage Waveforms

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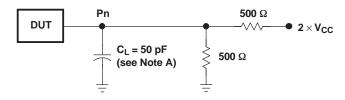


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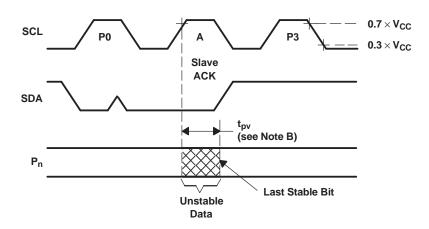
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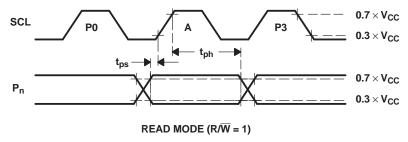
Parameter Measurement Information (continued)



P-PORT LOAD CONFIGURATION



WRITE MODE $(R/\overline{W} = 0)$



- A. C_L includes probe and jig capacitance.
- B. All inputs are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_0 = 50~\Omega$, $t_r/t_f \leq$ 30 ns.
- C. The outputs are measured one at a time, with one transition per measurement.
- D. All parameters and waveforms are not applicable to all devices.

Figure 16. P-Port Load Circuit And Voltage Waveforms

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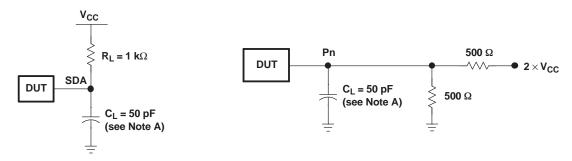


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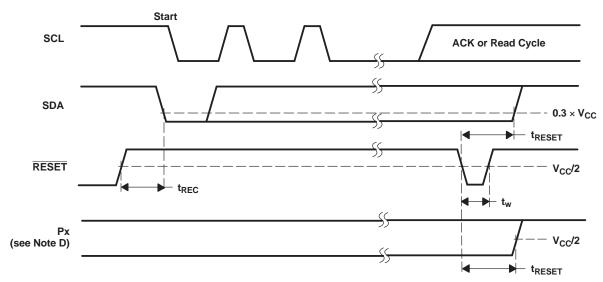
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Parameter Measurement Information (continued)



SDA LOAD CONFIGURATION

P-PORT LOAD CONFIGURATION



- A. C_L includes probe and jig capacitance.
- B. All inputs are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50~\Omega$, $t_r/t_f \leq$ 30 ns.
- C. The outputs are measured one at a time, with one transition per measurement.
- D. I/Os are configured as inputs.
- All parameters and waveforms are not applicable to all devices.

Figure 17. Reset Load Circuits And Voltage Waveforms

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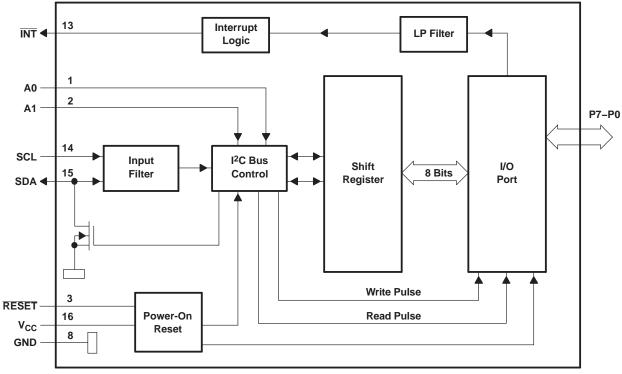
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8 Detailed Description

8.1 Functional Block Diagram



A. Pin numbers shown are for the DB, DBQ, DGV, DW, or PW package.

Figure 18. Functional Block Diagram

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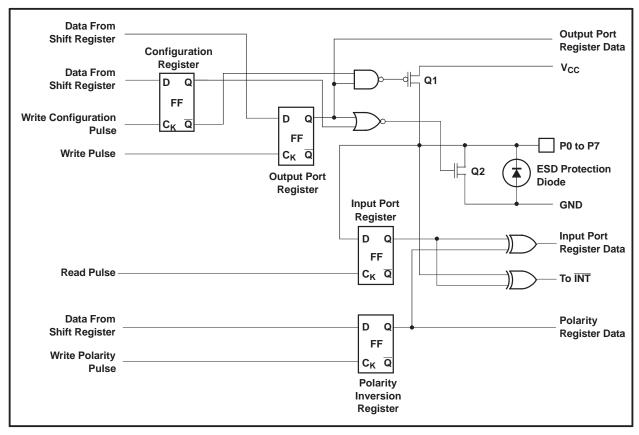


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Functional Block Diagram (continued)



A. At power-on reset, all registers return to default values.

Figure 19. Simplified Schematic Of P0 To P7

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15



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8.2 Device Functional Modes

8.2.1 RESET Input

The $\overline{\text{RESET}}$ input can be asserted to reset the system while keeping the V_{CC} at its operating level. A reset can be accomplished by holding the $\overline{\text{RESET}}$ pin low for a minimum of t_W. The PCA9538 registers and I²C/SMBus state machine are changed to their default states once $\overline{\text{RESET}}$ is low (0). Once $\overline{\text{RESET}}$ is high (1), the I/O levels at the P port can be changed externally or through the master. This input requires a pullup resistor to V_{CC} if no active connection is used.

8.2.1.1 RESET Errata

If RESET voltage set higher than VCC, current will flow from RESET pin to VCC pin.

System Impact

VCC will be pulled above its regular voltage level

System Workaround

Design such that RESET voltage is same or lower than VCC

8.2.2 Power-On Reset

When power (from 0 V) is applied to V_{CC} , an internal power-on reset holds the PCA9538 in a reset condition until V_{CC} has reached V_{POR} . At that point, the reset condition is released and the PCA9538 registers and SMBus/ I^2C state machine will initialize to their default states. After that, V_{CC} must be lowered to below 0.2 V and then back up to the operating voltage for a power-reset cycle.

Please refer to the *Power-On Reset Errata* section.

8.2.3 I/O Port

When an I/O is configured as an input, FETs Q1 and Q2 (in Figure 19) are off, creating a high-impedance input. The input voltage may be raised above V_{CC} to a maximum of 5.5 V.

If the I/O is configured as an output, Q1 or Q2 is enabled depending on the state of the output port register. In this case, there are low impedance paths between the I/O pin and either V_{CC} or GND. The external voltage applied to this I/O pin should not exceed the recommended levels for proper operation.



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Device Functional Modes (continued)

8.2.4 Interrupt Output (INT)

An interrupt is generated by any rising or falling edge of the port inputs in the input mode. After time, t_{iv}, the signal INT is valid. Resetting the interrupt circuit is achieved when data on the port is changed to the original setting, data is read from the port that generated the interrupt. Resetting occurs in the read mode at the acknowledge (ACK) or not acknowledge (NACK) bit after the rising edge of the SCL signal.

Interrupts that occur during the ACK or NACK clock pulse can be lost (or be very short) due to the resetting of the interrupt during this pulse. Each change of the I/Os after resetting is detected and is transmitted as INT. Writing to another device does not affect the interrupt circuit, and a pin configured as an output cannot cause an interrupt. Changing an I/O from an output to an input may cause a false interrupt to occur, if the state of the pin does not match the contents of the Input Port register. Because each 8-pin port is read independently, the interrupt caused by port 0 is not cleared by a read of port 1 or vice versa.

The INT output has an open-drain structure and requires pullup resistor to V_{CC}.

8.2.4.1 Interrupt Errata

The INT will be improperly de-asserted if the following two conditions occur:

1. The last I2C command byte (register pointer) written to the device was 00h.

NOTE

This generally means the last operation with the device was a Read of the input register. However, the command byte may have been written with 00h without ever going on to read the input register. After reading from the device, if no other command byte written, it will remain 00h.

2. Any other slave device on the I2C bus acknowledges an address byte with the R/W bit set high

System Impact

Can cause improper interrupt handling as the Master will see the interrupt as being cleared.

System Workaround

Minor software change: User must change command byte to something besides 00h after a Read operation to the PCA9538 device or before reading from another slave device.

NOTE

Software change will be compatible with other versions (competition and TI redesigns) of this device.

8.3 Programming

8.3.1 I²C Interface

The bidirectional I²C bus consists of the serial clock (SCL) and serial data (SDA) lines. Both lines must be connected to a positive supply through a pull-up resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

 I^2C communication with this device is initiated by a master sending a Start condition, a high-to-low transition on the SDA input/output while the SCL input is high (see Figure 20). After the Start condition, the device address byte is sent, most significant bit (MSB) first, including the data direction bit (R/W).

After receiving the valid address byte, this device responds with an acknowledge (ACK), a low on the SDA input/output during the high of the ACK-related clock pulse. The address inputs (A0–A1) of the slave device must not be changed between the Start and the Stop conditions.

On the I²C bus, only one data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the high pulse of the clock period, as changes in the data line at this time are interpreted as control commands (Start or Stop) (see Figure 21).

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Programming (continued)

A Stop condition, a low-to-high transition on the SDA input/output while the SCL input is high, is sent by the master (see Figure 20).

Any number of data bytes can be transferred from the transmitter to receiver between the Start and the Stop conditions. Each byte of eight bits is followed by one ACK bit. The transmitter must release the SDA line before the receiver can send an ACK bit. The device that acknowledges must pull down the SDA line during the ACK clock pulse so that the SDA line is stable low during the high pulse of the ACK-related clock period (see Figure 22). When a slave receiver is addressed, it must generate an ACK after each byte is received. Similarly, the master must generate an ACK after each byte that it receives from the slave transmitter. Setup and hold times must be met to ensure proper operation.

A master receiver will signal an end of data to the slave transmitter by not generating an acknowledge (NACK) after the last byte has been clocked out of the slave. This is done by the master receiver by holding the SDA line high. In this event, the transmitter must release the data line to enable the master to generate a Stop condition.

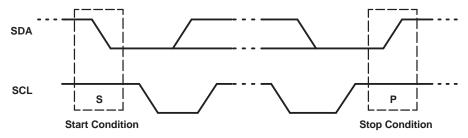


Figure 20. Definition Of Start And Stop Conditions

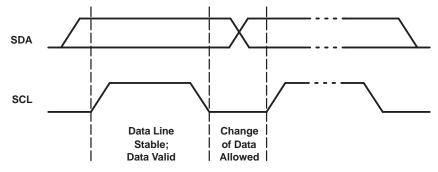


Figure 21. Bit Transfer

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Programming (continued)

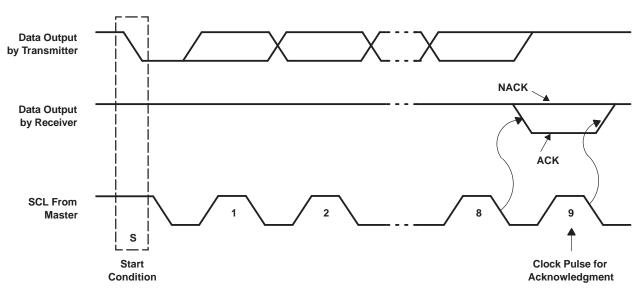


Figure 22. Acknowledgment On I²C Bus

8.3.2 Register Map

Table 1. Interface Definition Table

DVTE		BIT									
BYTE	7 (MSB)	6	5	4	3	2	1	0 (LSB)			
I ² C slave address	Н	Н	Н	L	L	A1	A0	R/W			
Px I/O data bus	P7	P6	P5	P4	P3	P2	P1	P0			

8.3.2.1 Device Address

Figure 23 shows the address byte of the PCA9538.

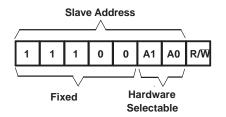


Figure 23. PCA9538 Address

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Table 2. Address Reference Table

INP	UTS	I ² C BUS SLAVE ADDRESS					
A1	A0	I C BUS SLAVE ADDRESS					
L	L	112 (decimal), 70 (hexadecimal)					
L	Н	113 (decimal), 71 (hexadecimal)					
Н	L	114 (decimal), 72 (hexadecimal)					
Н	Н	115 (decimal), 73 (hexadecimal)					

The last bit of the slave address defines the operation (read or write) to be performed. When it is high (1), a read is selected while a low (0) selects a write operation.

8.3.2.2 Control Register And Command Byte

Following the successful Acknowledgment of the address byte, the bus master sends a command byte that is stored in the control register in the PCA9538 (see Figure 24). Two bits of this command byte state the operation (read or write) and the internal register (input, output, polarity inversion or configuration) that will be affected. This register can be written or read through the I²C bus. The command byte is sent only during a write transmission.

Once a command byte has been sent, the register that was addressed continues to be accessed by reads until a new command byte has been sent.

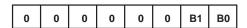


Figure 24. Control Register Bits

Table 3. Command Byte Table

CONTROL REG	ISTER BITS	COMMAND BYTE	REGISTER	PROTOCOL	POWER-UP DEFAULT	
B1	B1 B0		REGISTER	PROTOCOL	FOWER-OF DEFAULT	
0	0	0x00	Input Port	Read byte	XXXX XXXX	
0	1	0x01	Output Port	Read/write byte	1111 1111	
1	0	0x02	Polarity Inversion	Read/write byte	0000 0000	
1	1	0x03	Configuration	Read/write byte	1111 1111	

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8.3.2.3 Register Descriptions

The Input Port register (register 0) reflects the incoming logic levels of the pins, regardless of whether the pin is defined as an input or an output by the Configuration register. It only acts on read operation. Writes to these registers have no effect. The default value, X, is determined by the externally applied logic level.

Before a read operation, a write transmission is sent with the command byte to indicate to the I²C device that the Input Port register is accessed next.

Table 4. Register 0 (Input Port Register) Table

BIT	17	16	15	14	13	12	I1	10
DEFAULT	Х	Х	Χ	Х	Х	Х	Х	Х

The Output Port register (register 1) shows the outgoing logic levels of the pins defined as outputs by the Configuration register. Bit values in this register have no effect on pins defined as inputs. In turn, reads from this register reflect the value that is in the flip-flop controlling the output selection, not the actual pin value.

Table 5. Register 1 (Output Port Register) Table

BIT	07	O6	O5	O4	О3	O2	01	00
DEFAULT	1	1	1	1	1	1	1	1

The Polarity Inversion register (register 2) allows polarity inversion of pins defined as inputs by the Configuration register. If a bit in this register is set (written with 1), the corresponding port pin polarity is inverted. If a bit in this register is cleared (written with a 0), the corresponding port pin original polarity is retained.

Table 6. Register 2 (Polarity Inversion Register) Table

Ī	BIT	N7	N6	N5	N4	N3	N2	N1	N0
	DEFAULT	0	0	0	0	0	0	0	0

The Configuration register (register 3) configures the directions of the I/O pins. If a bit in this register is set to 1, the corresponding port pin is enabled as an input with a high-impedance output driver. If a bit in this register is cleared to 0, the corresponding port pin is enabled as an output.

Table 7. Register 3 (Configuration Register) Table

BIT	C7	C6	C5	C4	C3	C2	C1	C0
DEFAULT	1	1	1	1	1	1	1	1

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8.3.2.4 Bus Transactions

Data is exchanged between the master and PCA9538 through write and read commands.

8.3.2.4.1 Writes

Data is transmitted to the PCA9538 by sending the device address and setting the least-significant bit (LSB) to a logic 0 (see Figure 23 for device address). The command byte is sent after the address and determines which register receives the data that follows the command byte (see Figure 25 and Figure 26). There is no limitation on the number of data bytes sent in one write transmission.

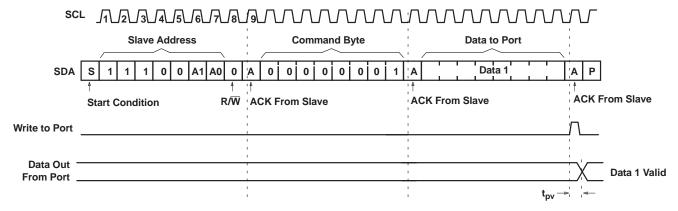


Figure 25. Write To Output Port Register

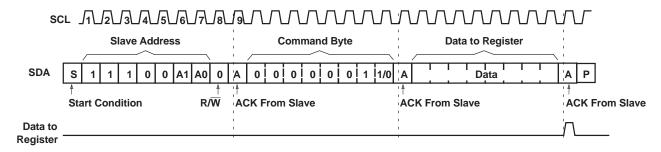


Figure 26. Write To Configuration Or Polarity Inversion Registers

8.3.2.4.2 Reads

The bus master first must send the PCA9538 address with the LSB set to a logic 0 (see Figure 23 for device address). The command byte is sent after the address and determines which register is accessed. After a restart, the device address is sent again but, this time, the LSB is set to a logic 1. Data from the register defined by the command byte then is sent by the PCA9538 (see Figure 27 and Figure 28). After a restart, the value of the register defined by the command byte matches the register being accessed when the restart occurred. Data is clocked into the register on the rising edge of the ACK clock pulse. There is no limitation on the number of data bytes received in one read transmission, but when the final byte is received, the bus master must not acknowledge the data.

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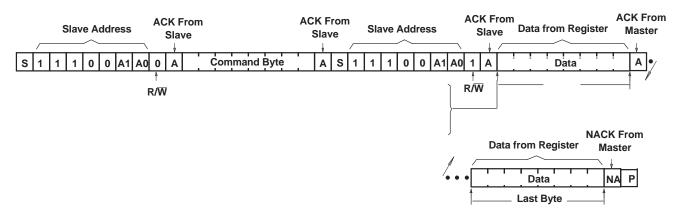
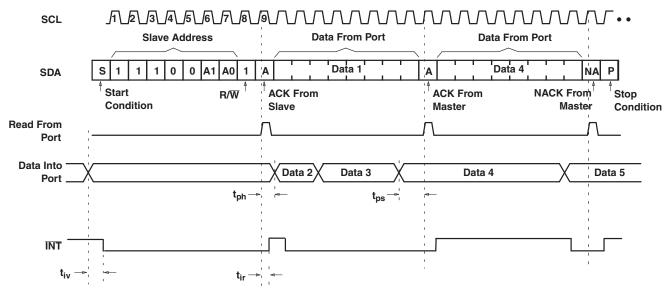


Figure 27. Read From Register



- A. This figure assumes the command byte has previously been programmed with 00h.
- B. Transfer of data can be stopped at any moment by a Stop condition.
- C. This figure eliminates the command byte transfer, a restart, and slave address call between the initial slave address call and actual data transfer from the P port. See Figure 27 for these details.

Figure 28. Read From Input Port Register

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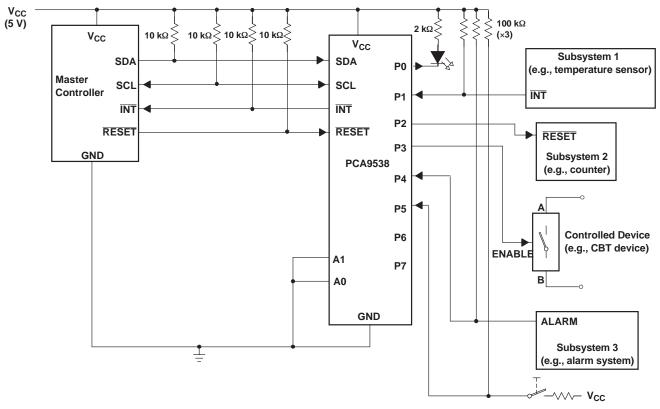
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9 Application And Implementation

9.1 Typical Application

Figure 29 shows an application in which the PCA9538 can be used.



- A. Device address is configured as 1110000 for this example.
- B. P0, P2, and P3 are configured as outputs.
- C. P1, P4, and P5 are configured as inputs.
- D. P6 and P7 are not used and must be configured as outputs.

Figure 29. Typical Application

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Typical Application (continued) 9.1.1 Detailed Design Procedure

9.1.1.1 Minimizing I_{CC} When I/Os Control Leds

When the I/Os are used to control LEDs, normally they are connected to V_{CC} through a resistor as shown in Figure 29. The LED acts as a diode, so when the LED is off, the I/O V_{IN} is about 1.2 V less than V_{CC} . I_{CC} in Electrical Characteristics shows how I_{CC} increases as V_{IN} becomes lower than V_{CC} .

For battery-powered applications, it is essential that the voltage of I/O pins is greater than or equal to V_{CC} when the LED is off to minimize current consumption. Figure 30 shows a high-value resistor in parallel with the LED. Figure 31 shows V_{CC} less than the LED supply voltage by at least 1.2 V. Both of these methods maintain the I/O V_{IN} at or above V_{CC} and prevents additional supply current consumption when the LED is off.

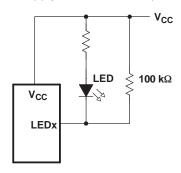


Figure 30. High-Value Resistor In Parallel With Led

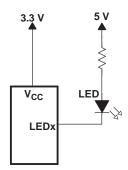


Figure 31. Device Supplied By A Lower Voltage

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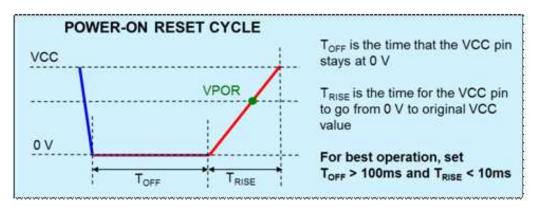
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10 Power Supply Recommendations

10.1 Power-On Reset Errata

A power-on reset condition can be missed if the VCC ramps are outside specification listed below.



System Impact

If ramp conditions are outside timing allowances above, POR condition can be missed, causing the device to lock

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11 Device and Documentation Support

11.1 Trademarks

All trademarks are the property of their respective owners.

11.2 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

11.3 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



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PACKAGE OPTION ADDENDUM

10-Jun-2014

PACKAGING INFORMATION

Lead/Ball Finish Orderable Device Status Package Type Package Pins Package Eco Plan MSL Peak Temp Op Temp (°C) **Device Marking** Samples Qty Drawing (1) (2) (6) (3) (4/5)ACTIVE SSOP CU NIPDAU Level-1-260C-UNLIM PD538 PCA9538DB 16 Green (RoHS DB 80 -40 to 85 Samples & no Sb/Br) CU NIPDAU PCA9538DBR **ACTIVE** SSOP DB Green (RoHS Level-1-260C-UNLIM PD538 16 2000 -40 to 85 Samples & no Sb/Br) PCA9538DBRG4 ACTIVE SSOP DB 16 2000 Green (RoHS CU NIPDAU Level-1-260C-UNLIM -40 to 85 PD538 Samples & no Sb/Br) PCA9538DGVR ACTIVE TVSOP DGV 16 Green (RoHS CU NIPDAU Level-1-260C-UNLIM -40 to 85 PD538 2000 Samples & no Sb/Br) PCA9538DW ACTIVE SOIC CU NIPDAU Level-1-260C-UNLIM PCA9538 DW 16 Green (RoHS -40 to 85 Samples & no Sb/Br) PCA9538DWR ACTIVE SOIC DW 16 Green (RoHS CU NIPDAU Level-1-260C-UNLIM -40 to 85 PCA9538 2000 Samples & no Sb/Br) PCA9538PW ACTIVE TSSOP PW Green (RoHS CU NIPDAU Level-1-260C-UNLIM PD538 16 90 -40 to 85 Samples & no Sb/Br) PCA9538PWG4 **ACTIVE** TSSOP PW 16 90 Green (RoHS CU NIPDAU Level-1-260C-UNLIM -40 to 85 PD538 Samples & no Sb/Br) PCA9538PWR ACTIVE TSSOP PW 16 2000 Green (RoHS CU NIPDAU Level-1-260C-UNLIM -40 to 85 PD538 Samples & no Sb/Br) PCA9538PWRG4 ACTIVE TSSOP PW 16 2000 Green (RoHS CU NIPDAU Level-1-260C-UNLIM -40 to 85 PD538 Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

& no Sb/Br)

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): Ti's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chips solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight



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- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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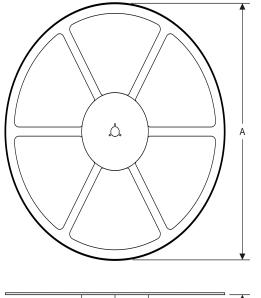


PACKAGE MATERIALS INFORMATION

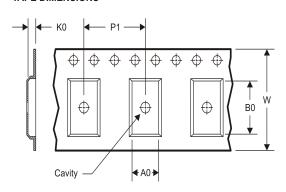
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TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers



TAPE AND REEL INFORMATION

*All dimensions are nominal

Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
PCA9538DBR	SSOP	DB	16	2000	330.0	16.4	8.2	6.6	2.5	12.0	16.0	Q1
PCA9538DGVR	TVSOP	DGV	16	2000	330.0	12.4	6.8	4.0	1.6	8.0	12.0	Q1
PCA9538DWR	SOIC	DW	16	2000	330.0	16.4	10.75	10.7	2.7	12.0	16.0	Q1
PCA9538PWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1



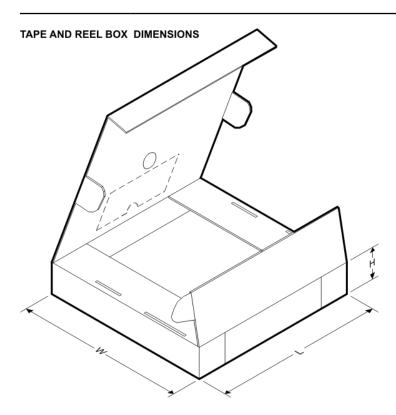
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PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

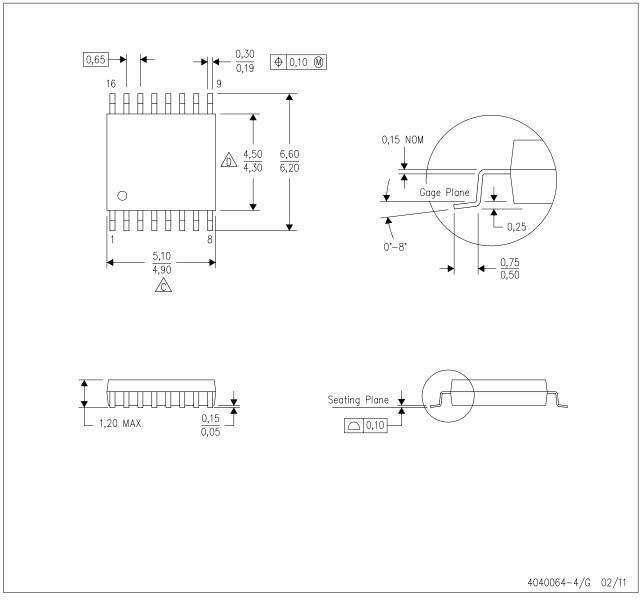
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Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
PCA9538DBR	SSOP	DB	16	2000	367.0	367.0	38.0
PCA9538DGVR	TVSOP	DGV	16	2000	367.0	367.0	35.0
PCA9538DWR	SOIC	DW	16	2000	367.0	367.0	38.0
PCA9538PWR	TSSOP	PW	16	2000	367.0	367.0	35.0



MECHANICAL DATA

PW (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M—1994.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
- E. Falls within JEDEC MO-153



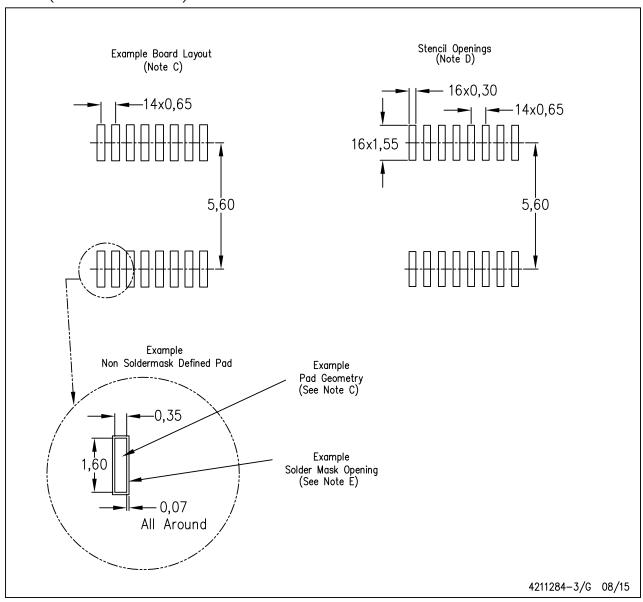




LAND PATTERN DATA

PW (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.





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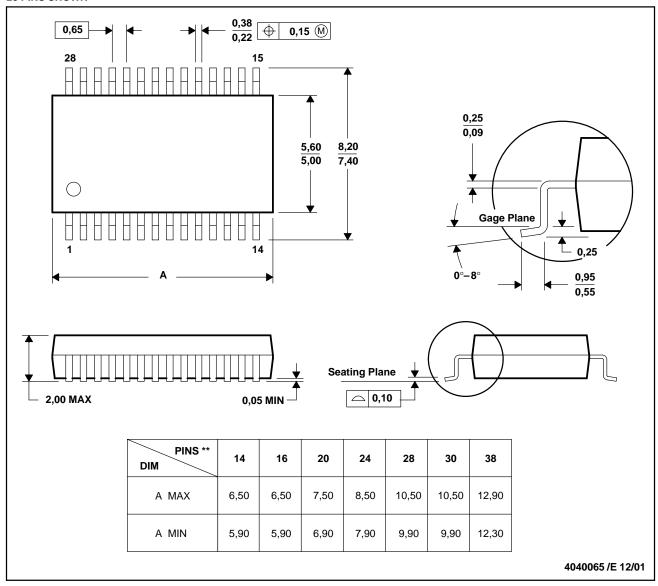
MECHANICAL DATA

MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

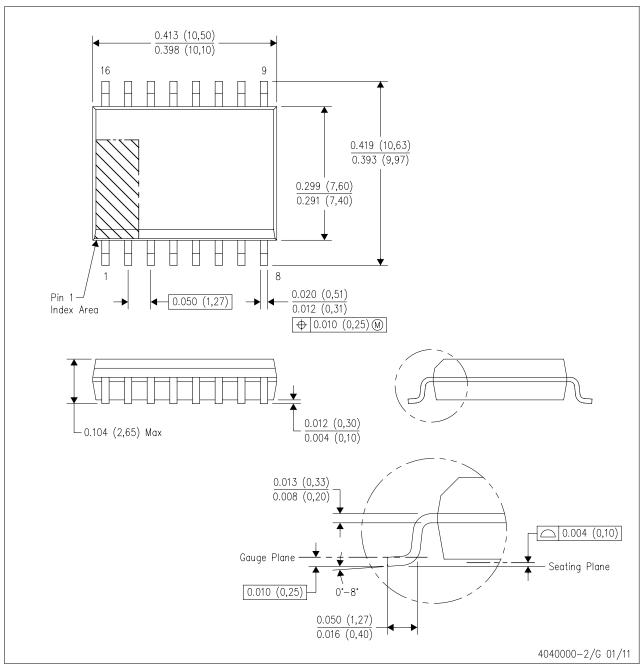




MECHANICAL DATA

DW (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M—1994.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AA.



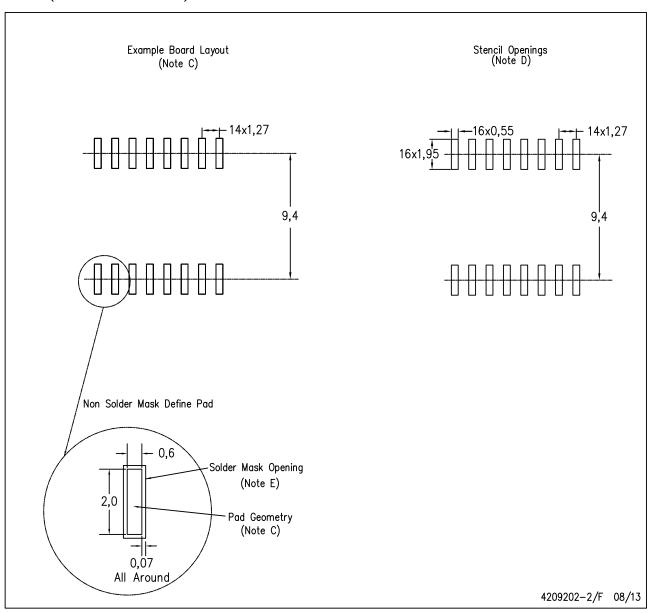




LAND PATTERN DATA

DW (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Refer to IPC7351 for alternate board design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.





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